INTEGRATED CIRCUITS

DATA SHEET

74LVC2G04Dual inverter

Product specification Supersedes data of 2003 Jul 22





Dual inverter 74LVC2G04

FEATURES

- Wide supply voltage range from 1.65 V to 5.5 V
- 5 V tolerant input/output for interfacing with 5 V logic
- · High noise immunity
- Complies with JEDEC standard:
 - JESD8-7 (1.65 V to 1.95 V)
 - JESD8-5 (2.3 V to 2.7 V)
 - JESD8B/JESD36 (2.7 V to 3.6 V).
- ESD protection:
 - HBM EIA/JESD22-A114-B exceeds 2000 V
 - MM EIA/JESD22-A115-A exceeds 200 V.
- ±24 mA output drive (V_{CC} = 3.0 V)
- CMOS low power consumption
- Latch-up performance exceeds 250 mA
- · Direct interface with TTL levels
- · Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C.

DESCRIPTION

The 74LVC2G04 is a high-performance, low-power, low-voltage, Si-gate CMOS device and superior to most advanced CMOS compatible TTL families.

Inputs can be driven from either 3.3 V or 5 V devices. These feature allows the use of these devices as translators in a mixed 3.3 V and 5 V environment.

This device is fully specified for partial power-down applications using I_{off} . The I_{off} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

The 74LVC2G04 provides two inverting buffers.

QUICK REFERENCE DATA

 $GND = 0 V; T_{amb} = 25 °C.$

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
t _{PHL} /t _{PLH}	propagation delay inputs nA to	$V_{CC} = 1.8 \text{ V}; C_L = 30 \text{ pF}; R_L = 1 \text{ k}\Omega$	3.5	ns
	outputs nY	$V_{CC} = 2.5 \text{ V}; C_L = 30 \text{ pF}; R_L = 500 \Omega$	2.2	ns
		$V_{CC} = 2.7 \text{ V}; C_L = 50 \text{ pF}; R_L = 500 \Omega$	2.7	ns
		$V_{CC} = 3.3 \text{ V}; C_L = 50 \text{ pF}; R_L = 500 \Omega$	2.7	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 50 \text{ pF}; R_L = 500 \Omega$	1.9	ns
Cı	input capacitance		2.5	pF
C _{PD}	power dissipation capacitance per gate	V _{CC} = 3.3 V; notes 1 and 2	13.5	pF

Notes

1. C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz;

f_o = output frequency in MHz;

C_L = output load capacitance in pF;

V_{CC} = supply voltage in Volts;

N = total load switching outputs;

 $\Sigma(C_L \times V_{CC}^2 \times f_0) = \text{sum of outputs.}$

2. The condition is $V_I = GND$ to V_{CC} .

Dual inverter 74LVC2G04

FUNCTION TABLE

See note 1.

INPUT	ОИТРИТ
nA	nY
L	Н
Н	L

Note

1. H = HIGH voltage level;

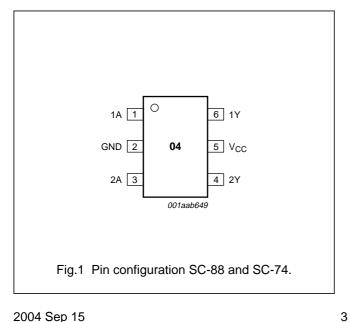
L = LOW voltage level.

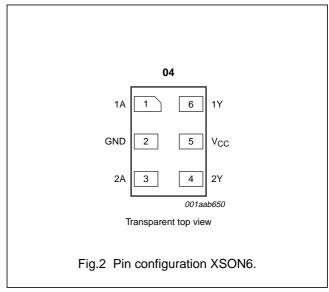
ORDERING INFORMATION

TYPE NUMBER	PACKAGE										
TIPE NUMBER	TEMPERATURE RANGE	PINS	PACKAGE	MATERIAL	CODE	MARKING					
74LVC2G04GW	–40 °C to +125 °C	6	SC-88	plastic	SOT363	V4					
74LVC2G04GV	–40 °C to +125 °C	6	SC-74	plastic	SOT457	V04					
74LVC2G04GM	–40 °C to +125 °C	6	XSON6	plastic	SOT886	V4					

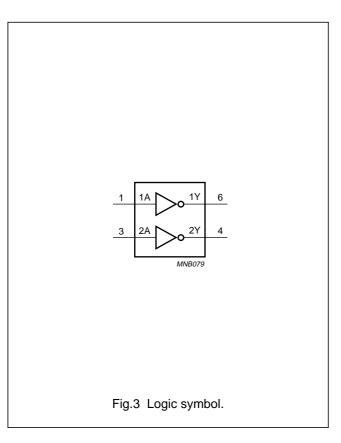
PINNING

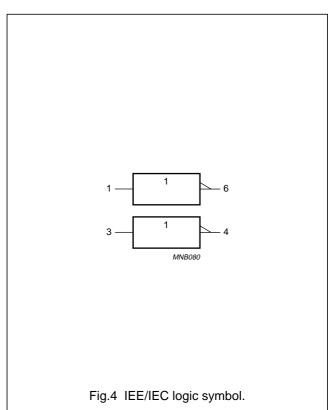
PIN	SYMBOL	DESCRIPTION
1	1A	data input
2	GND	ground (0 V)
3	2A	data input
4	2Y	data output
5	V _{CC}	supply voltage
6	1Y	data output

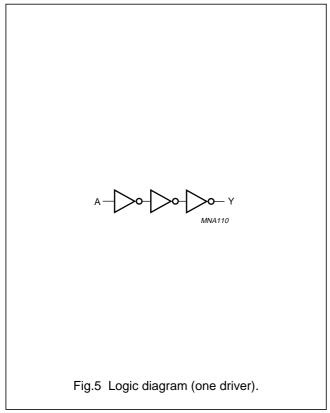




Dual inverter 74LVC2G04







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4

Dual inverter 74LVC2G04

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CC}	supply voltage		1.65	5.5	V
VI	input voltage		0	5.5	V
Vo	output voltage	active mode	0	V _{CC}	V
		V _{CC} = 0 V; Power-down mode	0	5.5	V
T _{amb}	operating ambient temperature		-40	+125	°C
t _r , t _f	input rise and fall times	V _{CC} = 1.65 V to 2.7 V	0	20	ns/V
		V _{CC} = 2.7 V to 5.5 V	0	10	ns/V

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134); voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input diode current	V _I < 0 V	_	-50	mA
VI	input voltage	note 1	-0.5	+6.5	V
I _{OK}	output diode current	V _O > V _{CC} or V _O < 0 V	_	±50	mA
Vo	output voltage	active mode; notes 1 and 2	-0.5	V _{CC} + 0.5	V
		Power-down mode; notes 1 and 2	-0.5	+6.5	V
I _O	output source or sink current	$V_O = 0 \text{ V to } V_{CC}$	_	±50	mA
I _{CC} , I _{GND}	V _{CC} or GND current		_	±100	mA
T _{stg}	storage temperature		-65	+150	°C
P _D	power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$	_	300	mW

Notes

- 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
- 2. When $V_{CC} = 0 \text{ V}$ (Power-down mode), the output voltage can be 5.5 V in normal operation.

Dual inverter 74LVC2G04

DC CHARACTERISTICS

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

SYMBOL	DADAMETED	TEST COND	ITIONS		TVD (1)	MAN	
SYMBOL	PARAMETER	OTHER	V _{CC} (V)	MIN.	TYP. ⁽¹⁾	MAX.	UNIT
T _{amb} = -40) °C to +85 °C		-	1	'	•	1
V _{IH}	HIGH-level input voltage		1.65 to 1.95	$0.65 \times V_{CC}$	_	_	V
			2.3 to 2.7	1.7	_	_	V
			2.7 to 3.6	2.0	_	_	V
			4.5 to 5.5	$0.7 \times V_{CC}$	_	_	V
V _{IL}	LOW-level input voltage		1.65 to 1.95	_	_	$0.35 \times V_{CC}$	V
			2.3 to 2.7	_	_	0.7	V
			2.7 to 3.6	_	_	0.8	V
			4.5 to 5.5	_	_	$0.3 \times V_{CC}$	V
V _{OL}	LOW-level output voltage	$V_I = V_{IH}$ or V_{IL}					
		I _O = 100 μA	1.65 to 5.5	_	_	0.1	V
		I _O = 4 mA	1.65	_	_	0.45	V
		I _O = 8 mA	2.3	_	_	0.3	V
		I _O = 12 mA	2.7	_	_	0.4	V
		I _O = 24 mA	3.0	_	_	0.55	V
		I _O = 32 mA	4.5	_	_	0.55	V
V _{OH}	HIGH-level output	$V_I = V_{IH}$ or V_{IL}					
	voltage	$I_{O} = -100 \mu\text{A}$	1.65 to 5.5	V _{CC} – 0.1	_	_	V
		$I_O = -4 \text{ mA}$	1.65	1.2	_	_	V
		$I_O = -8 \text{ mA}$	2.3	1.9	_	_	V
		$I_0 = -12 \text{ mA}$	2.7	2.2	_	_	V
		$I_{O} = -24 \text{ mA}$	3.0	2.3	_	_	V
		$I_0 = -32 \text{ mA}$	4.5	3.8	_	_	V
ILI	input leakage current	V _I = 5.5 V or GND	5.5	_	±0.1	±5	μΑ
I _{off}	power OFF leakage current	V_I or $V_O = 5.5 \text{ V}$	0	_	±0.1	±10	μΑ
Icc	quiescent supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A	5.5	_	0.1	10	μΑ
Δl _{CC}	additional quiescent supply current per pin	$V_I = V_{CC} - 0.6 \text{ V};$ $I_O = 0 \text{ A}$	2.3 to 5.5	_	5	500	μΑ

Dual inverter 74LVC2G04

OVMDOL	DADAMETED	TEST COND	ITIONS		TVD (1)	MAY	
SYMBOL	PARAMETER	OTHER	V _{CC} (V)	MIN.	TYP.(1)	MAX.	UNIT
T _{amb} = -40) °C to +125 °C		•			!	'
V _{IH}	HIGH-level input voltage		1.65 to 1.95	0.65 × V _{CC}	_	_	V
			2.3 to 2.7	1.7	_	_	V
			2.7 to 3.6	2.0	_	_	V
			4.5 to 5.5	$0.7 \times V_{CC}$	_	_	V
V _{IL}	LOW-level input voltage		1.65 to 1.95	_	_	$0.35 \times V_{CC}$	V
			2.3 to 2.7	_	_	0.7	V
			2.7 to 3.6	_	_	0.8	V
			4.5 to 5.5	_	_	$0.3 \times V_{CC}$	V
V _{OL}	LOW-level output voltage	$V_I = V_{IH}$ or V_{IL}					
		l _O = 100 μA	1.65 to 5.5	_	_	0.1	V
		I _O = 4 mA	1.65	_	_	0.70	V
		I _O = 8 mA	2.3	_	_	0.45	V
		I _O = 12 mA	2.7	_	_	0.60	V
		I _O = 24 mA	3.0	_	_	0.80	V
		I _O = 32 mA	4.5	_	_	0.80	V
V _{OH}	HIGH-level output	$V_I = V_{IH}$ or V_{IL}					
	voltage	$I_{O} = -100 \mu\text{A}$	1.65 to 5.5	V _{CC} – 0.1	_	_	V
		$I_O = -4 \text{ mA}$	1.65	0.95	_	_	V
		$I_O = -8 \text{ mA}$	2.3	1.7	_	_	V
		$I_0 = -12 \text{ mA}$	2.7	1.9	_	_	V
		$I_{O} = -24 \text{ mA}$	3.0	2.0	_	_	V
		$I_0 = -32 \text{ mA}$	4.5	3.4	_	_	V
ILI	input leakage current	$V_I = 5.5 \text{ V or GND}$	5.5	_	_	±20	μΑ
I _{off}	power OFF leakage current	V_I or $V_O = 5.5 \text{ V}$	0	_	_	±20	μА
I _{cc}	quiescent supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A	5.5	_	_	40	μΑ
ΔI_{CC}	additional quiescent supply current per pin	$V_{I} = V_{CC} - 0.6 \text{ V};$ $I_{O} = 0 \text{ A}$	2.3 to 5.5	_	_	5000	μА

Note

1. All typical values are measured at V_{CC} = 3.3 V and T_{amb} = 25 $^{\circ}C.$

Dual inverter 74LVC2G04

AC CHARACTERISTICS

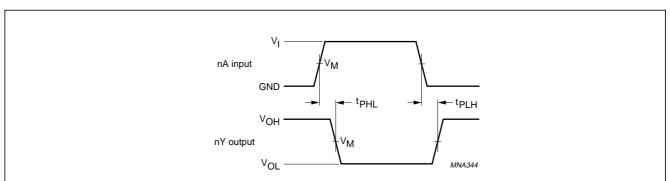
GND = 0 V.

SYMBOL		TEST CON	DITIONS		T)(D (1)	14 A W		
SYMBOL	PARAMETER	WAVEFORMS	V _{CC} (V)	MIN.	TYP. ⁽¹⁾	MAX.	UNIT	
T _{amb} = -40 °	C to +85 °C	•	•	•			-1	
t _{PHL} /t _{PLH}	propagation delay	see Figs 6 and 7	1.65 to 1.95	1.0	3.5	8.0	ns	
	nA to nY		2.3 to 2.7	1.0	2.2	4.4	ns	
			2.7	1.0	2.7	5.2	ns	
			3.0 to 3.6	0.5	2.7	4.1	ns	
			4.5 to 5.5	1.0	1.9	3.2	ns	
T _{amb} = -40 °	C to +125 °C			•				
t _{PHL} /t _{PLH}	propagation delay	see Figs 6 and 7	1.65 to 1.95	1.0	_	9.5	ns	
	nA to nY		2.3 to 2.7	1.0	_	5.4	ns	
			2.7	1.0	-	7.0	ns	
			3.0 to 3.6	0.5	-	5.5	ns	
			4.5 to 5.5	1.0	-	3.8	ns	

Note

1. All typical values are measured at T_{amb} = 25 °C.

AC WAVEFORMS

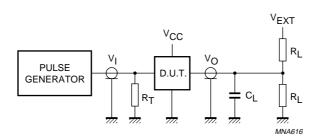


V	V	INF	PUT
V _{CC}	V _M	VI	$t_r = t_f$
1.65 V to 1.95 V	$0.5 \times V_{CC}$	V _{CC}	≤ 2.0 ns
2.3 V to 2.7 V	$0.5 \times V_{CC}$	V _{CC}	≤ 2.0 ns
2.7 V	1.5 V	2.7 V	≤ 2.5 ns
3.0 V to 3.6 V	1.5 V	2.7 V	≤ 2.5 ns
4.5 V to 5.5 V	$0.5 \times V_{CC}$	V _{CC}	≤ 2.5 ns

 V_{OL} and V_{OH} are typical output voltage drop that occur with the output load.

Fig.6 Input nA to output nY propagation delay times.

Dual inverter 74LVC2G04



V	V.	C	D.	V _{EXT}
V _{CC}	V _I	CL	R _L	t _{PLH} /t _{PHL}
1.65 V to 1.95 V	V _{CC}	30 pF	1 kΩ	open
2.3 V to 2.7 V	V _{CC}	30 pF	500 Ω	open
2.7 V	2.7 V	50 pF	500 Ω	open
3.0 V to 3.6 V	2.7 V	50 pF	500 Ω	open
4.5 V to 5.5 V	V _{CC}	50 pF	500 Ω	open

Definitions for test circuit:

R_L = Load resistor.

 C_L = Load capacitance including jig and probe capacitance.

 $R_{T} = Termination$ resistance should be equal to the output impedance Z_{0} of the pulse generator.

Fig.7 Load circuitry for switching times.

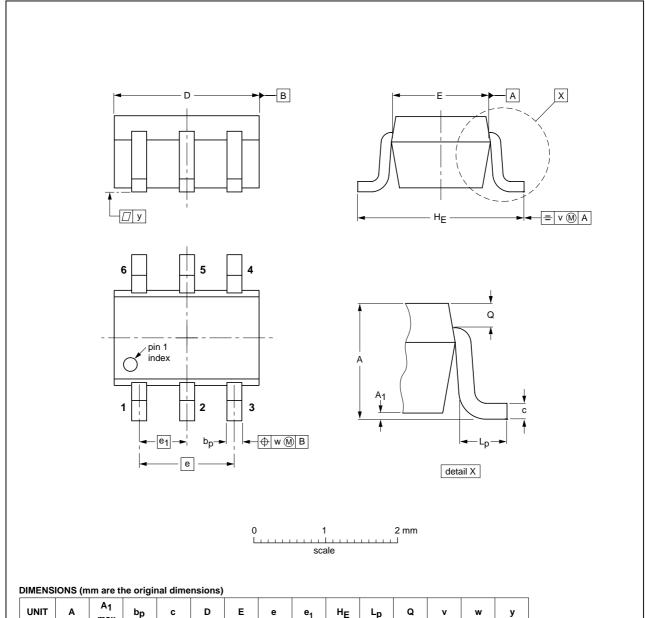
9

Dual inverter 74LVC2G04

PACKAGE OUTLINES

Plastic surface mounted package; 6 leads

SOT363



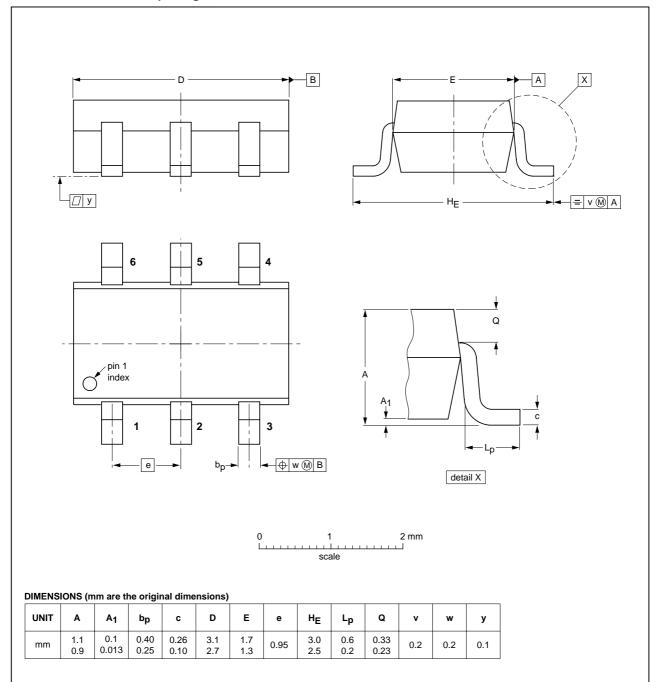
UNIT	A	A ₁ max	bp	С	D	E	е	e ₁	HE	Lp	Q	v	w	у
mm	1.1 0.8	0.1	0.30 0.20	0.25 0.10	2.2 1.8	1.35 1.15	1.3	0.65	2.2 2.0	0.45 0.15	0.25 0.15	0.2	0.2	0.1

OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT363			SC-88			97-02-28

Dual inverter 74LVC2G04

Plastic surface mounted package; 6 leads

SOT457

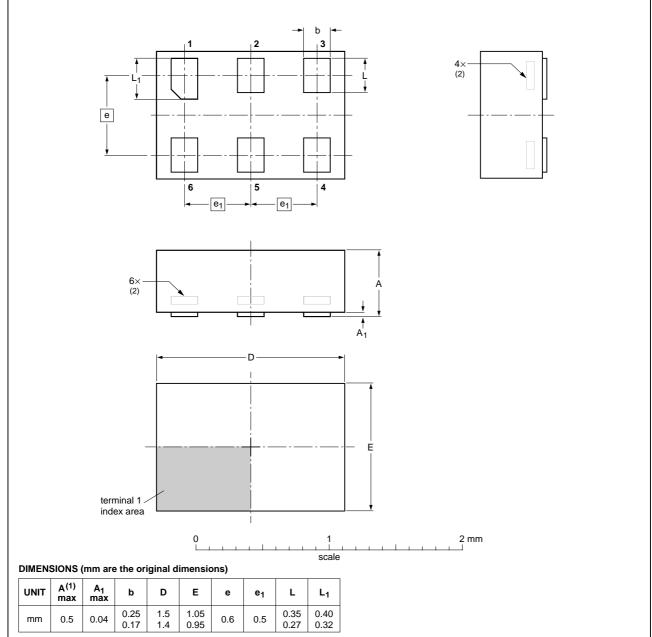


OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT457			SC-74			97-02-28 01-05-04

Dual inverter 74LVC2G04

XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1.45 x 0.5 mm

SOT886



Notes

- Including plating thickness.
 Can be visible in some manufacturing processes.

OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT886		MO-252				-04-07-15 04-07-22

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DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS(2)(3)	DEFINITION
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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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SCA76

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